



# Suspension design for ET – thermal noise of cryogenic optics –



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ET Design Study – contract # 211743

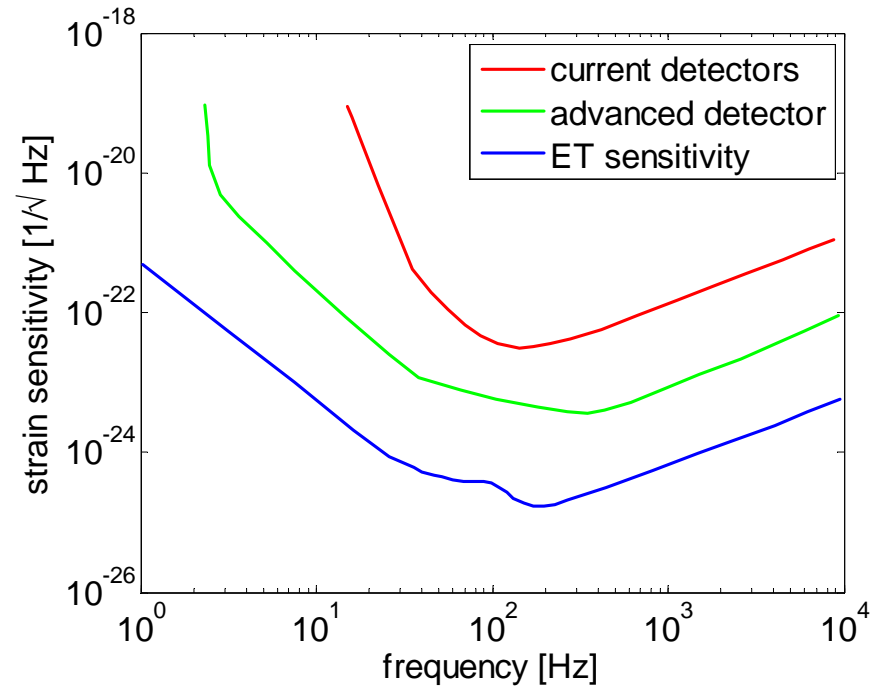
# Overview

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- introduction (ET, desired design sensitivity...)
- mirror thermal noise (initial guess of geometry)
- overview of possible coating techniques  
(dielectric, resonant waveguide, monolithic)
- open questions, tasks to be done

# Introduction

- ET - Einstein Telescope
- 3<sup>rd</sup> generation detector
- sensitivity improvement by a factor of 10 in all frequency regions
- considered:
  - sophisticated suspension system (superattenuator)
  - arm length ~ 10 km, underground
  - squeezed light, non-Gaussian beams
  - cryogenics



# Thermal noise calculation

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- restrictions for this talk:
  - only end mirror considered
  - start with Advanced LIGO geometry (crosscheck possible)
  
- reasons:
  - transmissive components could be avoided (use of all-reflective components)
  - contribution of tantala layers can be reduced (e.g. thickness, novel concepts)
  - thus, further reduction of thermorefractive noise

# Main thermal noise contribution

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- Brownian thermal noise
  - bulk material
  - coating material
  
- thermoelastic noise
  - bulk material
  - coating material
  
- other contributions were lower for final mirror
  
- detailed calculation including temperature dependent values  $\leftrightarrow$  BENCH

# Bulk Brownian Noise

infinite test mass: 
$$S_X^{ITM}(f, T) = \frac{2k_B T}{\pi^{3/2} f} \times \frac{1 - \sigma^2}{w Y} \times \phi_{\text{substrate}}(f, T)$$

[Liu, Thorne 2000]

finite test mass: 
$$S_X^{FTM}(f, T) = C_{FTM}^2 \times S_X^{ITM}(f, T)$$

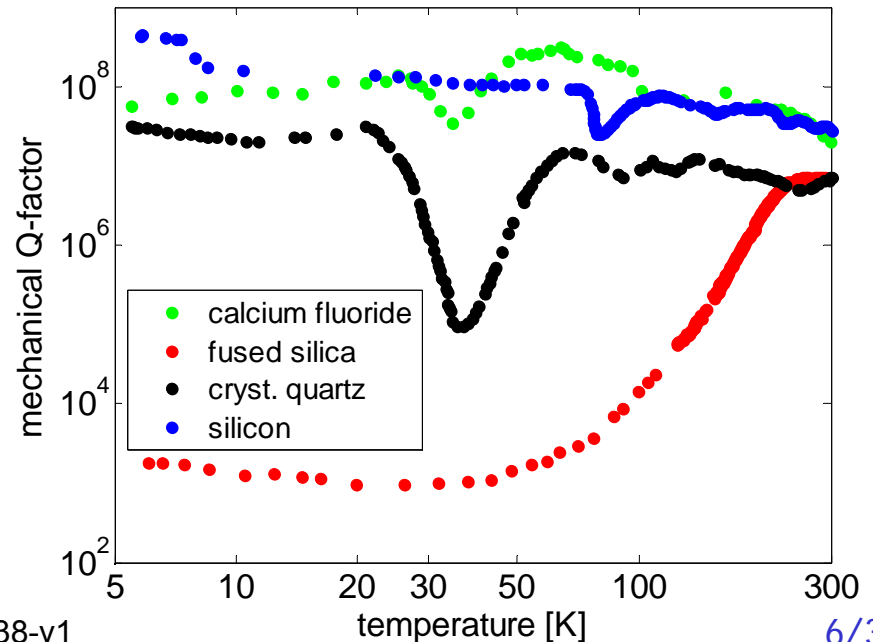
[Liu, Thorne 2000; Bondu, Hello, Vinet 1998]

- material selection:

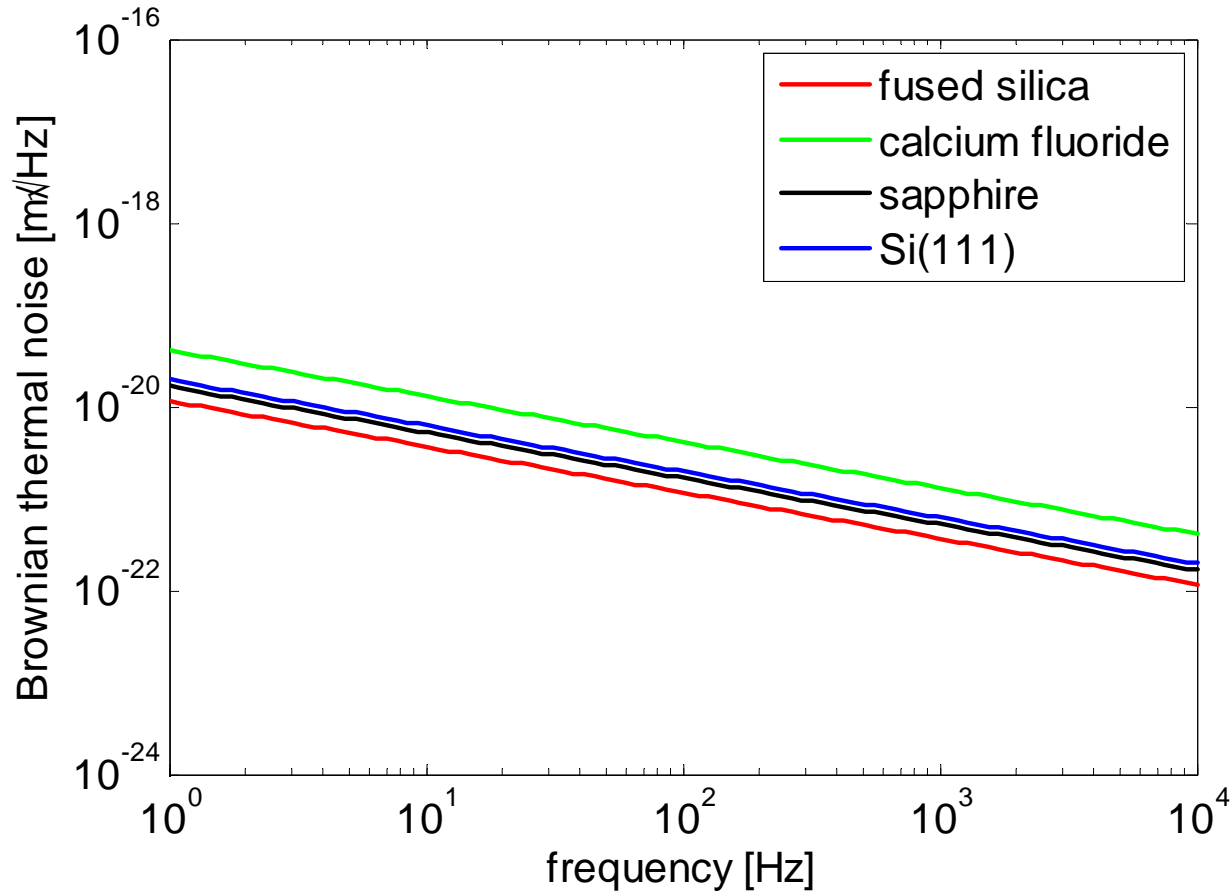
- Young's modulus  $Y$
- mechanical loss  $\phi$

mechanical Q-factor measurements

[see Chr. Schwarz's talk]

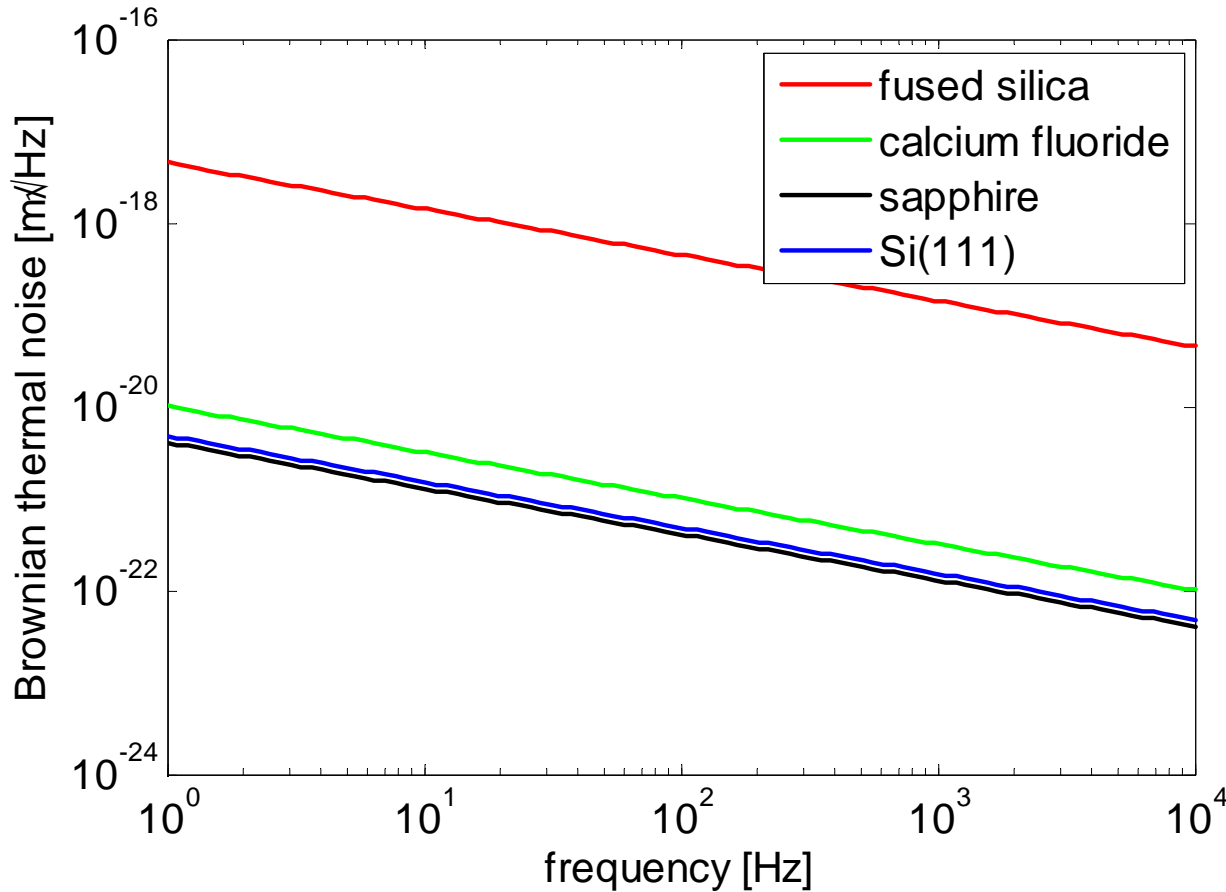


# Bulk Brownian Noise



300 K

# Bulk Brownian Noise



18 K

high mechanical loss of silica at 18 K ( $\phi \sim 10^{-3}$ )



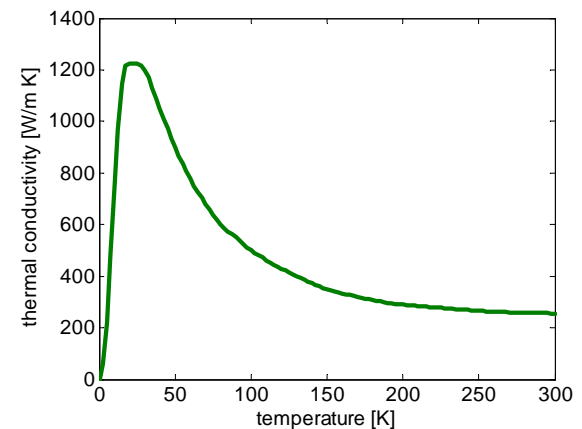
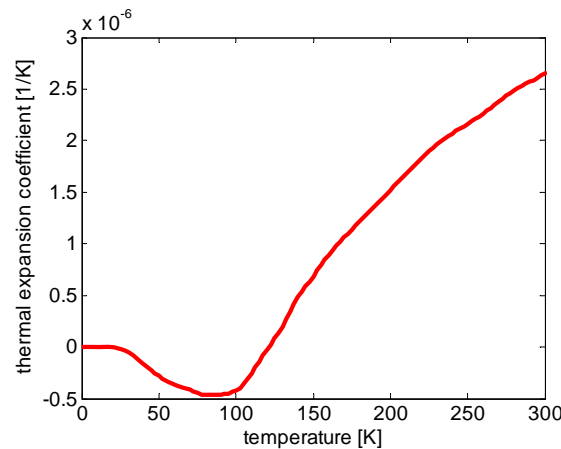
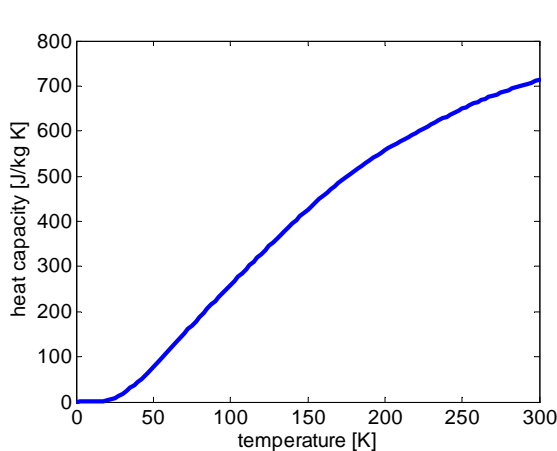


# Bulk thermoelastic noise

infinite test mass: 
$$S_{TE}^{ITM}(f, T) = \frac{4k_B T^2 \alpha^2 (1 + \sigma)^2 \kappa}{\pi^{5/2} \rho^2 C^2 f^2 w^3}$$

finite test mass: 
$$S_{TE}^{FTM}(f, T) = C_{FTM}^{\prime 2} \times S_{TE}^{ITM}(f, T) \quad [\text{Liu, Thorne 2000}]$$

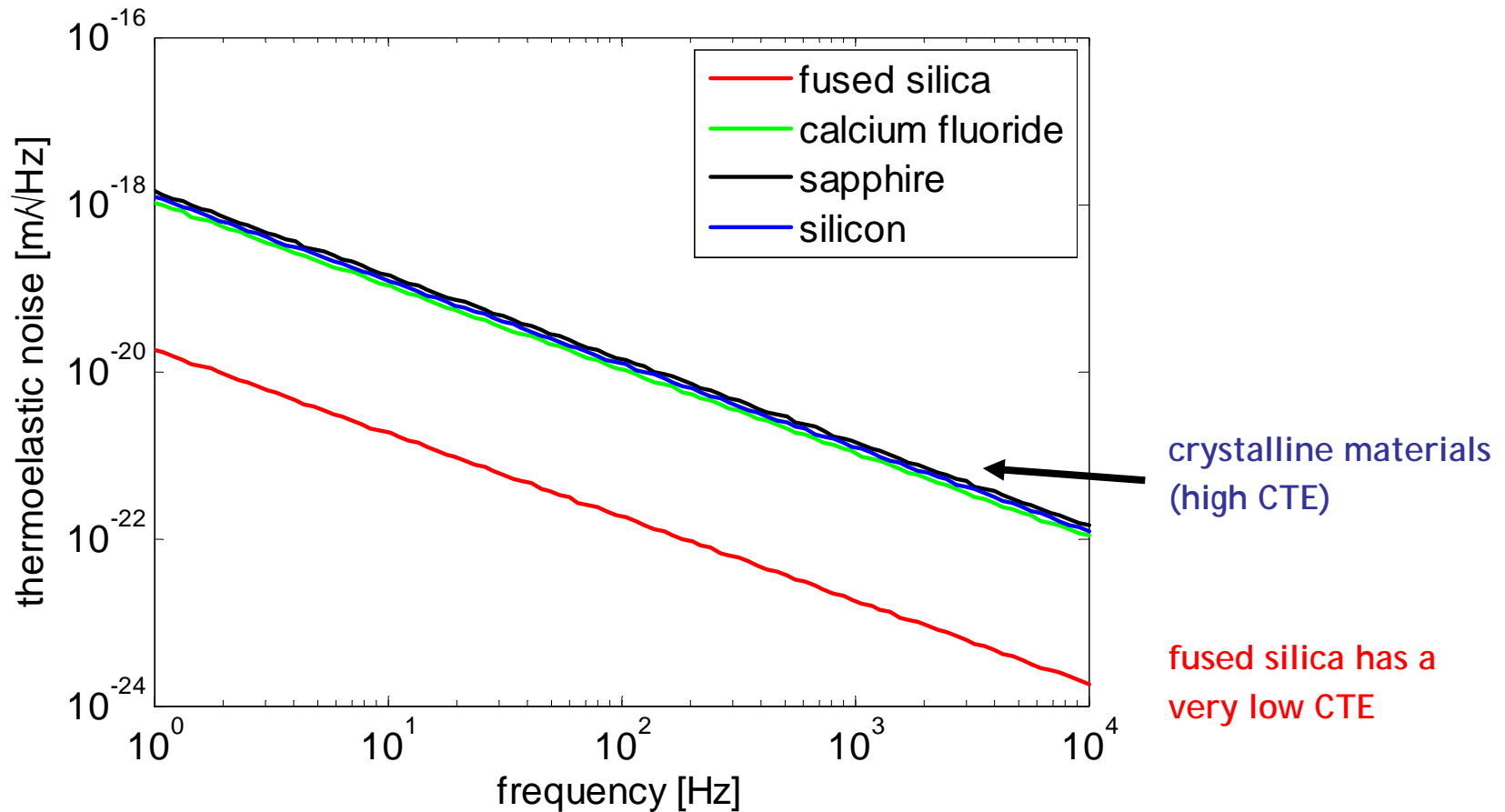
- thermal properties (thermal expansion, heat capacity and thermal conductivity) govern thermoelastic noise
- e.g. silicon:



[Hull 1999]

# Bulk thermoelastic noise

- thermoelastic (room temperature)



# Bulk thermoelastic noise

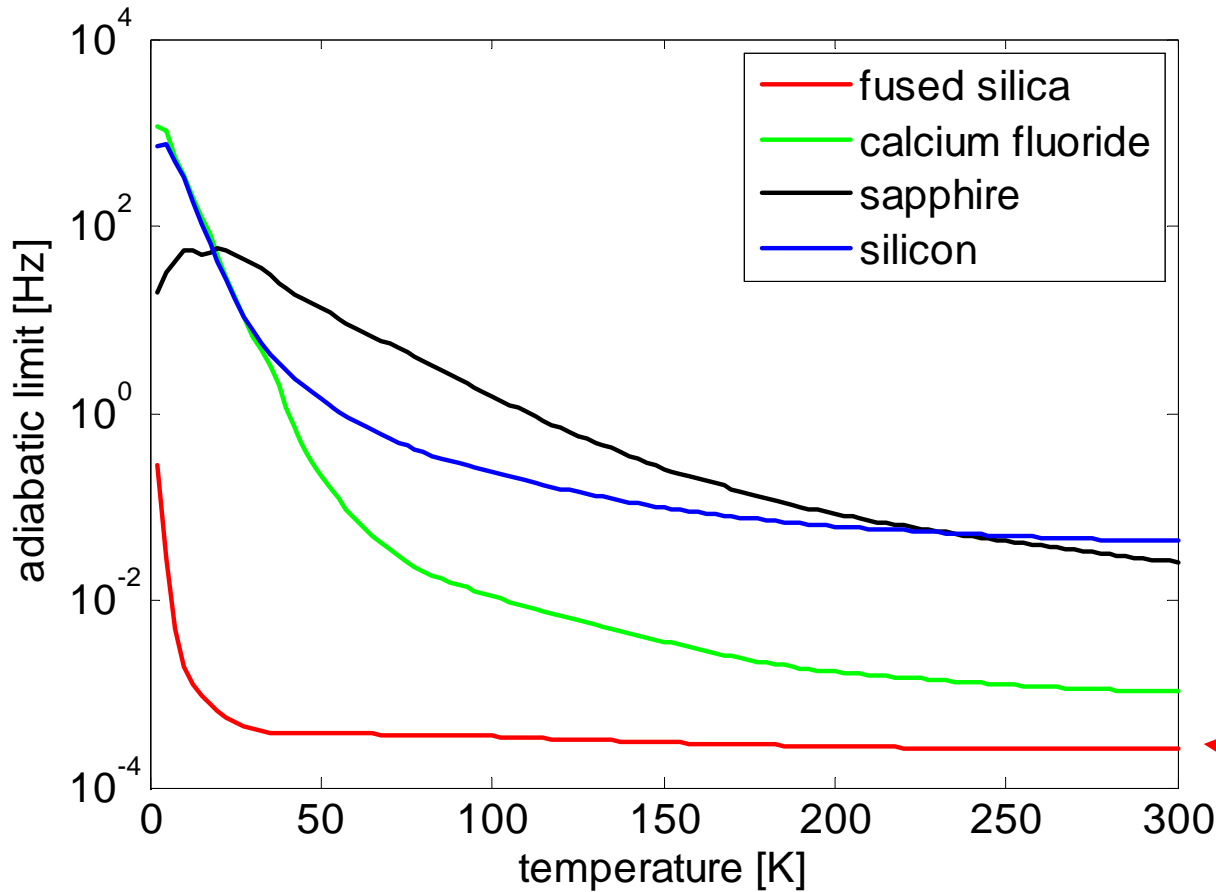
- thermoelastic (low temperatures)
  - crystalline materials have higher thermal conductivity at low temperatures
  - reduced amount of fluctuating heat contributes to thermoelastic noise (“non-adiabatic” case)

$$S_{TE}(f, T) = \frac{8}{\sqrt{2\pi}} \alpha^2 (1 + \sigma)^2 \frac{k_B T^2 r_0}{\kappa} \times J(\Omega) \quad \begin{array}{l} \text{[Rowan et al. 2000, Aspen Meeting]} \\ \text{[Cerdonio 2001]} \end{array}$$

$$J(\Omega) = \sqrt{\frac{2}{\pi^3}} \int_0^{\infty} du \int_{-\infty}^{+\infty} dv \frac{u^3 e^{-u^2/2}}{(u^2 + v^2)[(u^2 + v^2)^2 + \Omega^2]}$$

$$\Omega = \frac{\omega}{\omega_C} \quad \text{with the adiabatic limit} \quad \omega_C = \frac{\kappa}{\rho C r_0^2}$$

# Bulk thermal noise

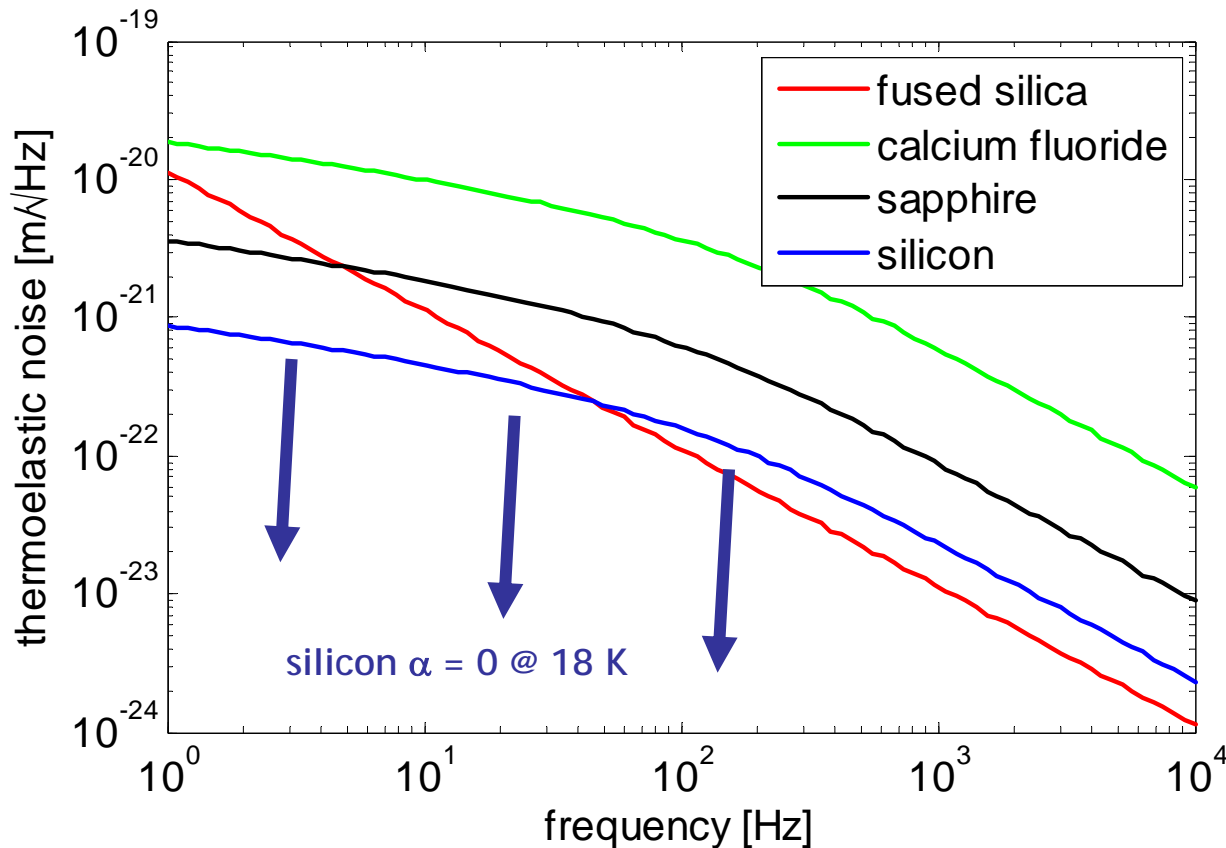


w = 60 mm

← coatings stay adiabatic

# Bulk thermal noise

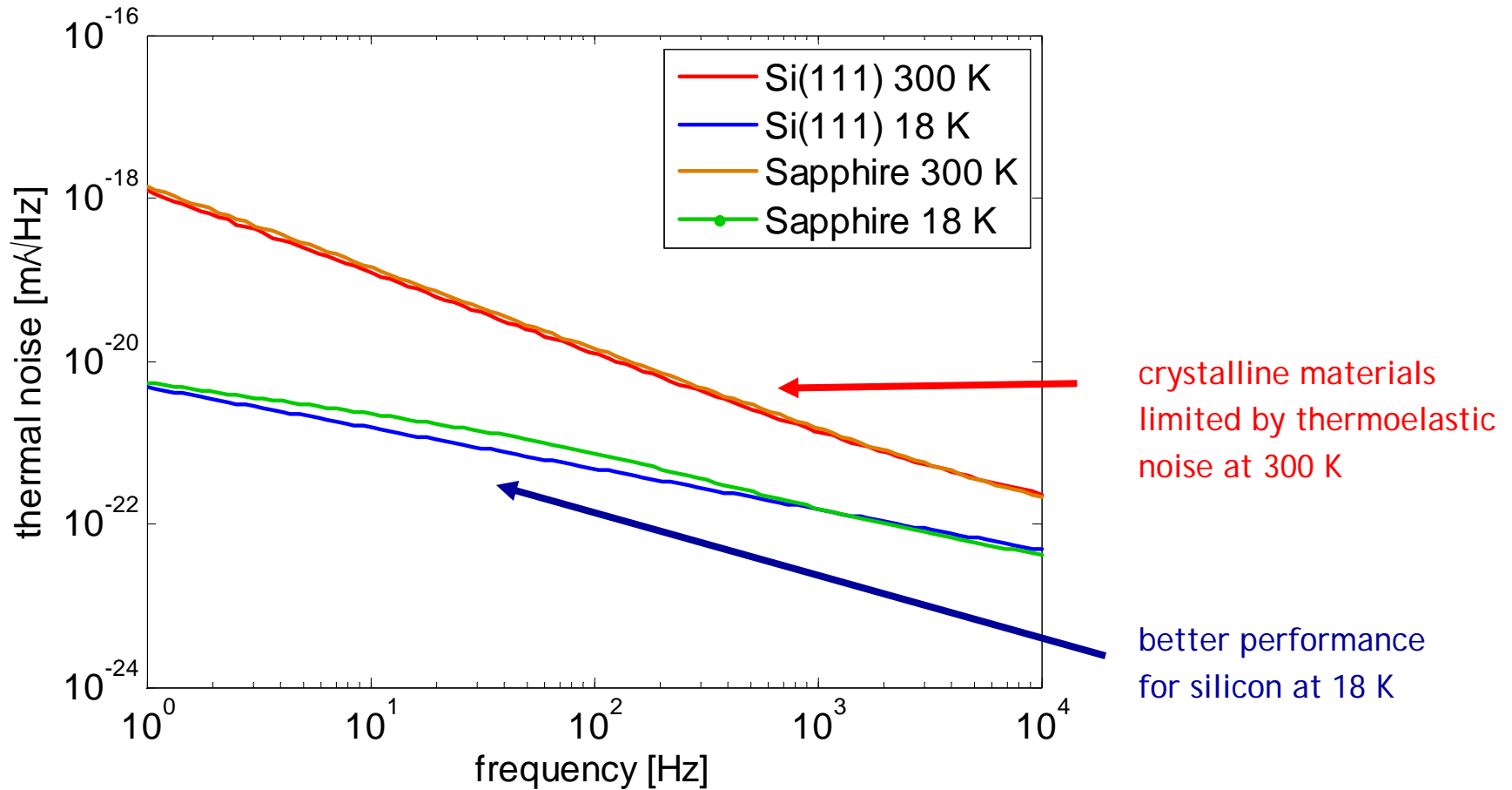
- thermoelastic (~18 K, full calculation)



- reduction of thermoelastic noise in the low frequency band
- higher thermoelastic noise for amorphous materials at 18 K

# Bulk thermal noise

- total bulk thermal noise (Brownian + TE)



# Coating thermal noise

- Brownian thermal noise

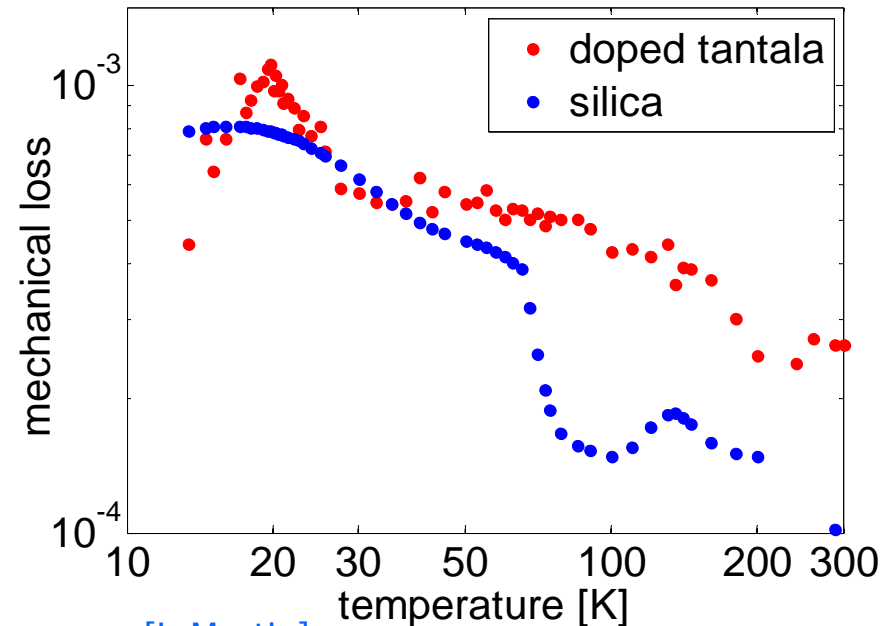
infinite test mass: 
$$S_x(f, T) \approx \frac{2k_B T}{\pi^2 f} \frac{d}{w^2 Y} \left( \frac{Y'}{Y} \phi_{\parallel} + \frac{Y}{Y'} \phi_{\perp} \right)$$

finite test mass: ANSYS + Levin's direct approach [Levin 1998]  
 calculation by [K. Somiya et al., LIGO-P080121-00-Z]

- material selection:
  - Young's modulus and ratio
  - mechanical loss

mechanical loss measurements

[see I. Martin's talk]



[I. Martin]

# Coating thermal noise

- thermoelastic noise

$$S_{TE}(f, T) = \frac{8k_B T^2}{\pi^2 f} \frac{L}{w^2} \frac{\alpha_S C_F}{C_S} (1 + \sigma_s)^2 \tilde{\Delta}^2 g(\omega)$$

[Braginsky, Fejer et al. 2004]

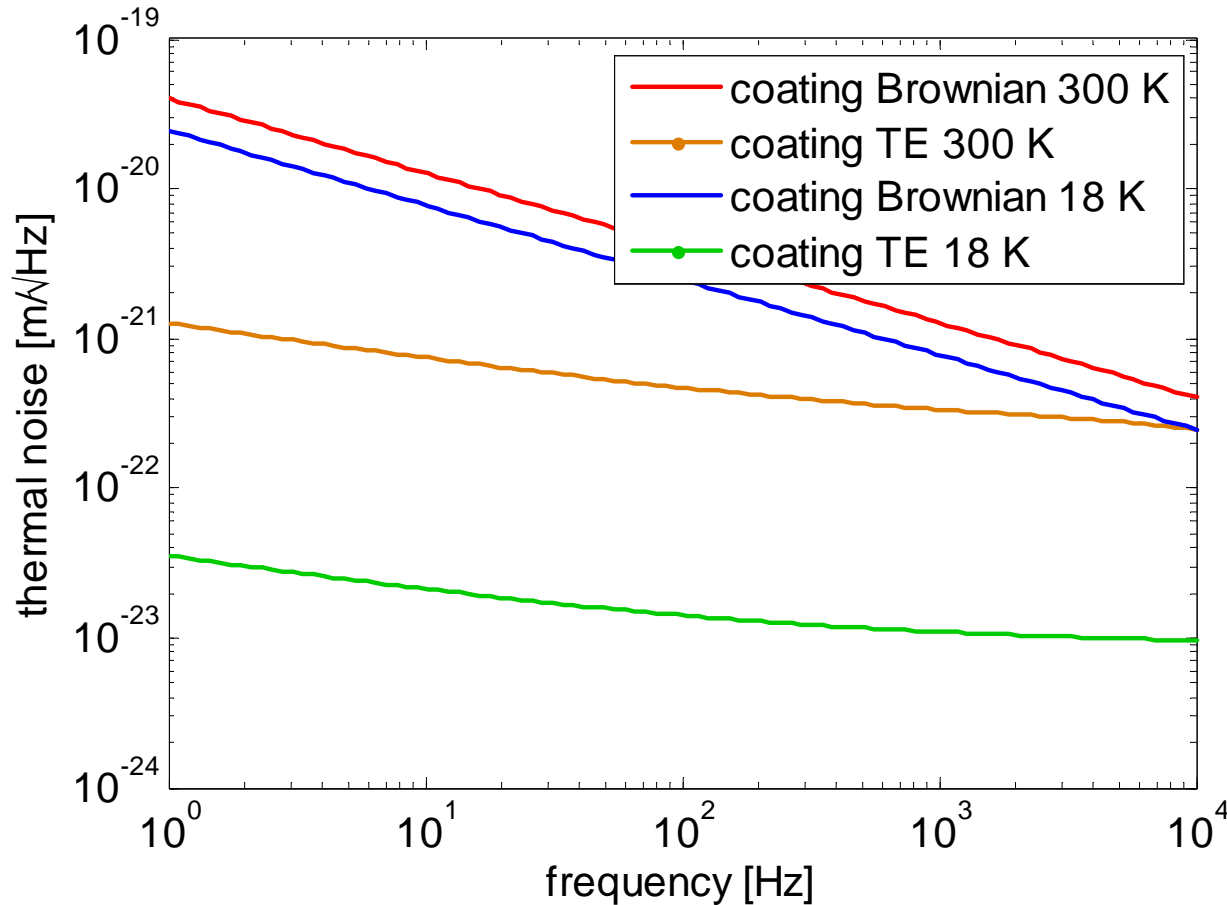
$$\tilde{\Delta}^2 = \left\{ \frac{C_S}{2\alpha_S C_F} \left( \frac{\alpha}{1-\sigma} \left[ \frac{1+\sigma}{1+\sigma_S} + (1-2\sigma_S) \frac{E}{E_S} \right] \right)_{AVG} - 1 \right\}^2$$

$$g(\omega) = \text{Im} \left[ -\frac{1}{\sqrt{i\omega\tau_F}} \frac{\sinh \sqrt{i\omega\tau_F}}{\cosh \sqrt{i\omega\tau_F} + R \sinh \sqrt{i\omega\tau_F}} \right] \quad \tau_F = \frac{L^2}{\kappa} \quad \text{and} \quad R = \sqrt{\frac{\kappa_F C_F^2}{\kappa_S C_S^2}}$$

- thermoelastic noise is also dependent on material combination
- coating material = amorphous → no further reduction by “non-adiabatic” case



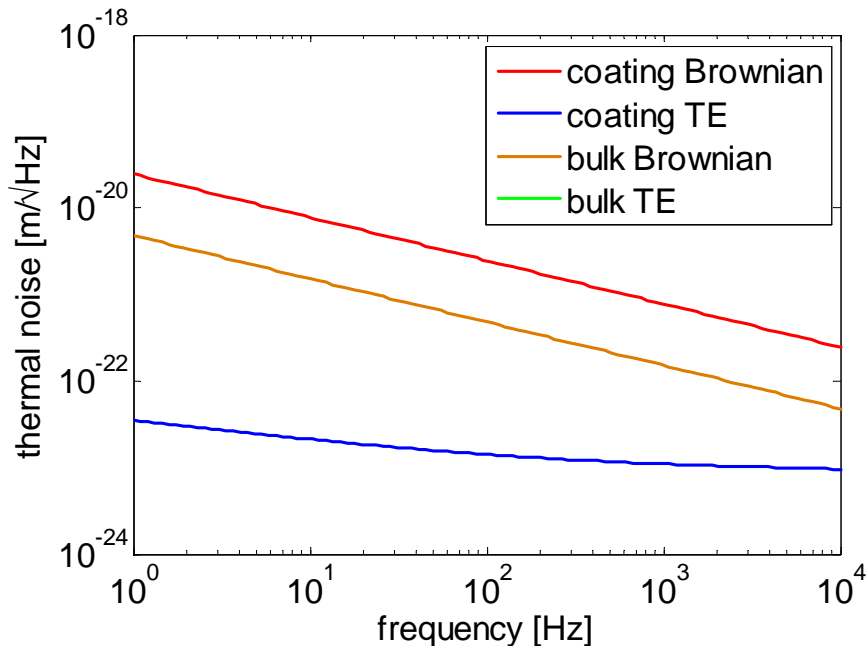
# Coating thermal noise



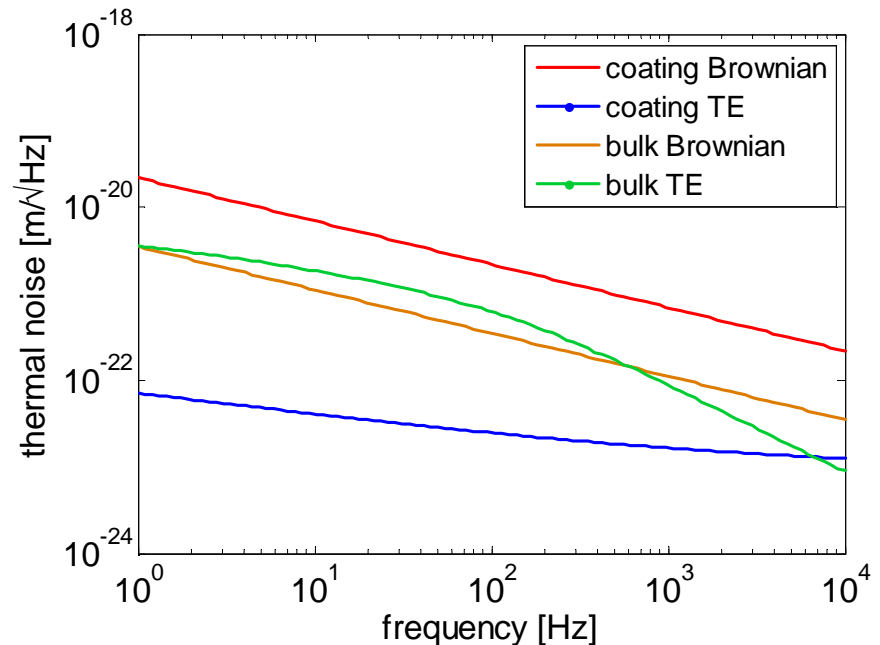
Brownian noise dominates at room temperature and cryogenics

# Mirror thermal noise

Si(111)



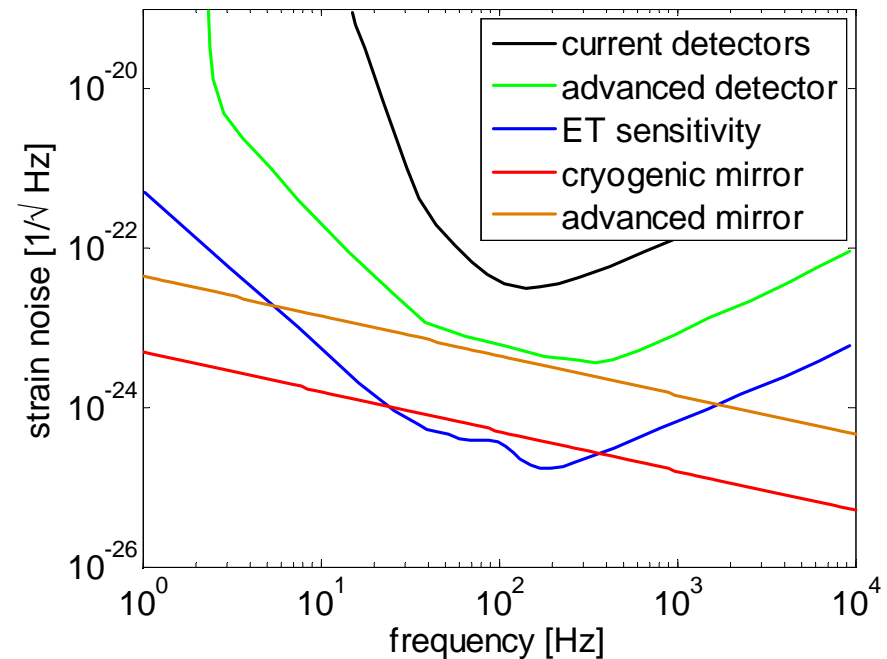
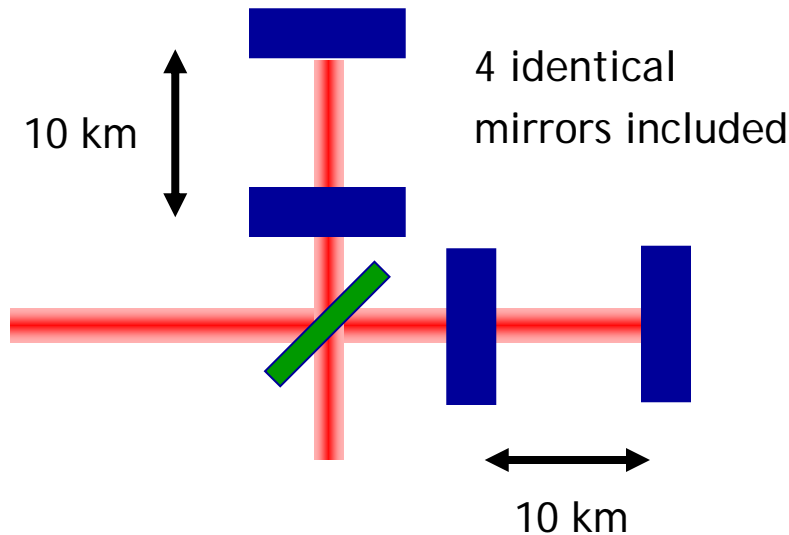
Sapphire



→ currently, the bulk material selection is not driven by bulk thermal noise  
 advantage of silicon: availability in large pieces (semiconductor industry!)

# Mirror thermal noise

- strain sensitivity curve



Just changing the material of an Advanced Ligo mirror brings us close to ET's sensitivity curve - but there is still sensitivity missing.

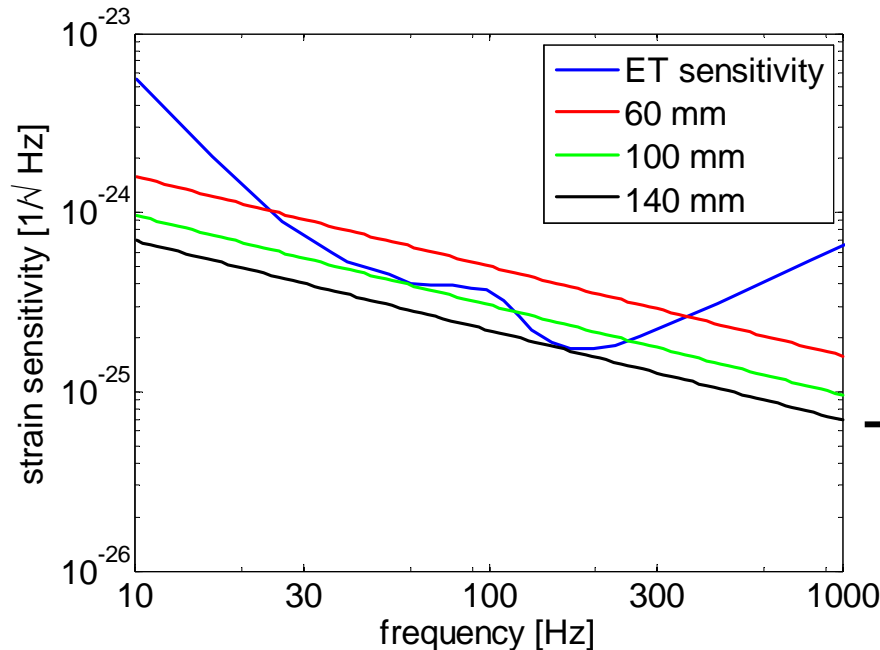
# Mirror thermal noise

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- possible techniques to further reduce thermal noise
  - bigger beam diameter
  - better coatings
  - reduced coating thickness (optimized coatings, resonant waveguide mirrors)
  - monolithic resonant waveguides in silicon

# Upscaling

- increasing the beam diameter with constant mirror aspect ratio

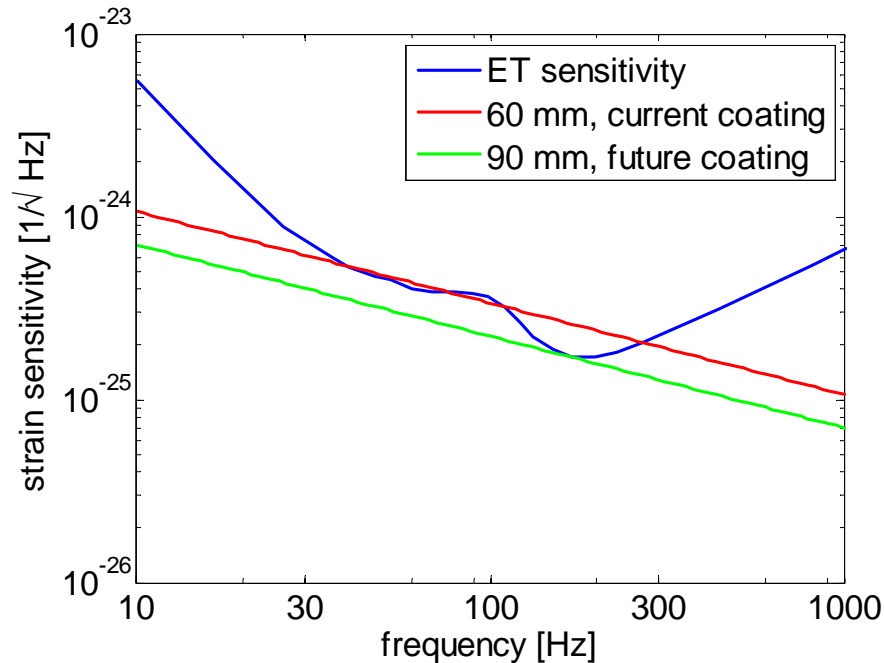


→ 532 kg needed  
+  
ROC currently not achievable

- what mass is needed (radiation pressure)
  - ~ 120 kg [S. Hild et al., arXiv: 0810.0604v2]
  - (probably more: up to 200 kg - but to be added in thickness)

# Towards a realistic geometry

- assuming 150 kg and Advanced Ligo aspect ratio



- needs coating improvement at 18 K to:  
 $2 \times 10^{-4}$  (silica) and  $4 \times 10^{-4}$  (tantala)

[see I. Martin's talk]

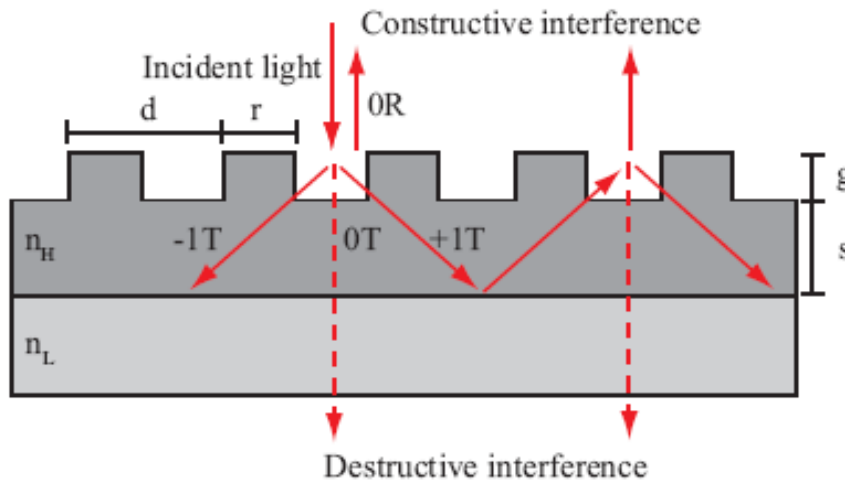
# Challenges with dielectric coatings

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- mechanical loss needs to be reduced at cryogenic temperatures
- local heating?  
multilayer stack forms thermal insulator between absorbing part and well conducting substrate → massive local heating?
- optical absorption (e.g. 1-3 MW, 1 ppm)

# Resonant Waveguide Concept

- optical idea



[Brückner et al., Optics Express 17 (2009) 163 - 169]

no 1st orders in air and substrate

+/- 1st order in high index material

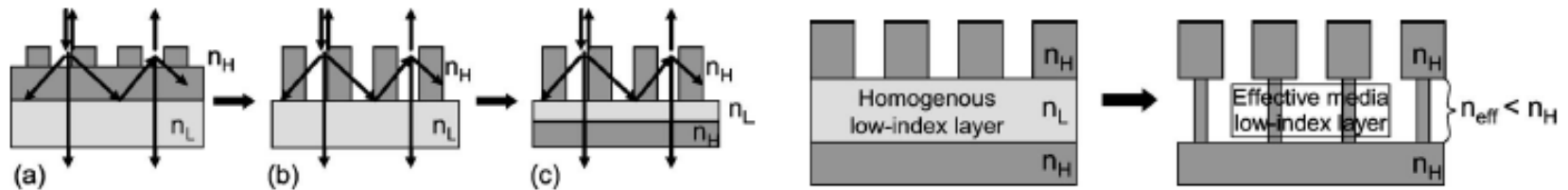
[H. Lück's talk]

- advantages from the thermal noise point of view (thinner tantala layer!)
- cooling issues (lower absorption due to thinner layers)



# Monolithic Resonant Waveguide Concept

- optical idea

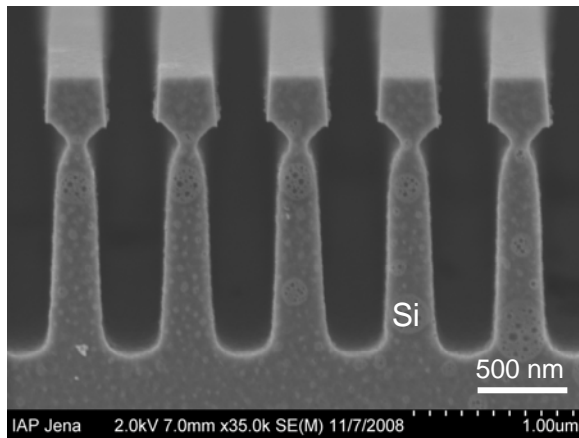


[Brückner et al., Optics Letters 33 (2008) 264 - 266]

- no tantala layer needed (expected low loss)
- monocrystalline structure → high thermal conductivity
- probably just small absorption at 1550 nm (R. Schnabel's talk @ Amaldi 2009)

# Monolithic Resonant Waveguide Concept

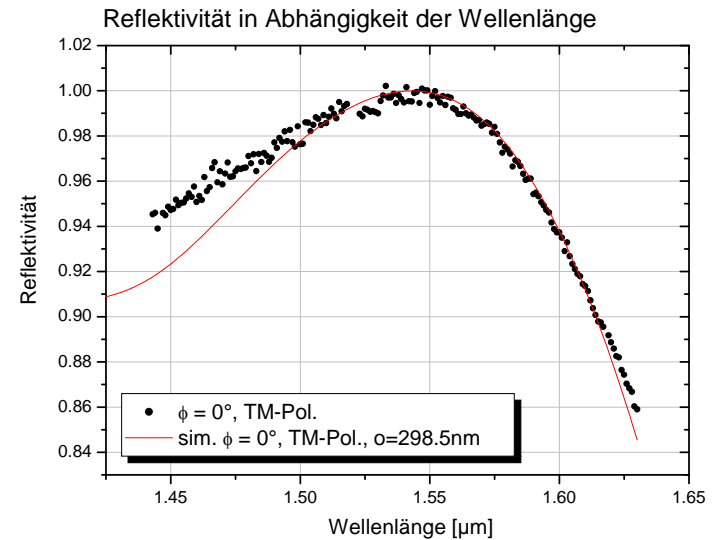
How realistic are these fancy structures?



fist design



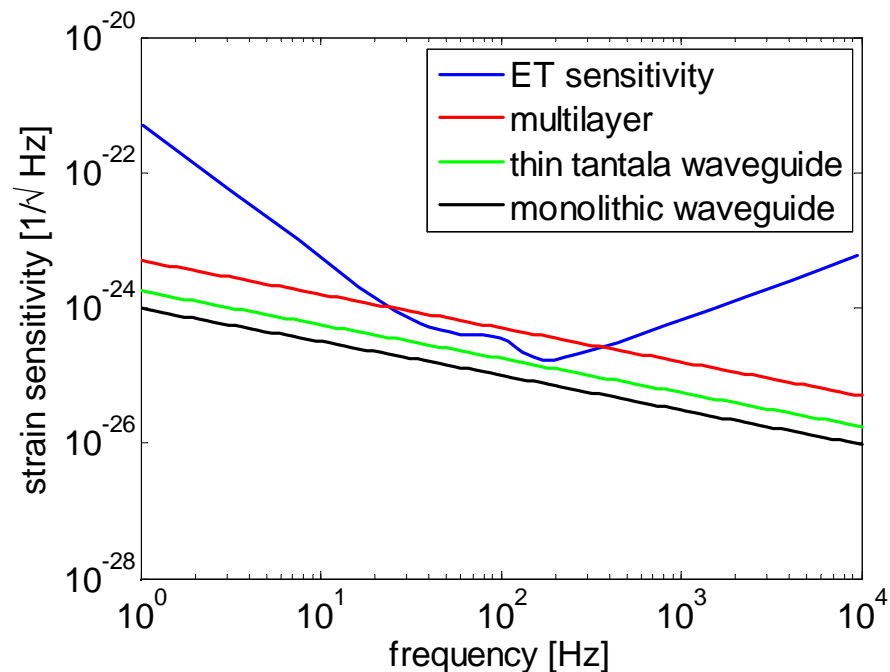
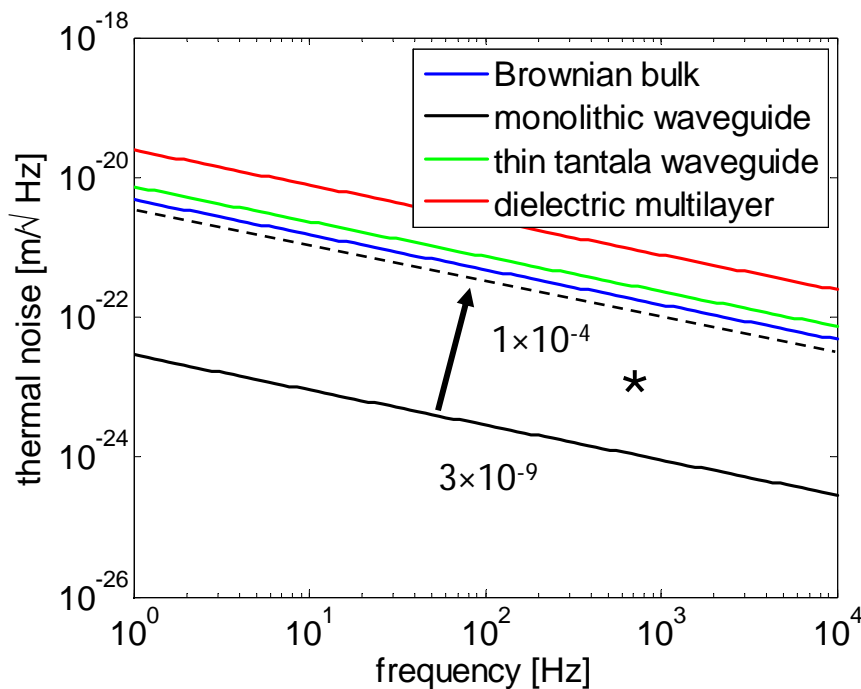
first initial test: ~ 99.8%



see details in talk of F. Brückner @ Amaldi

# Initial thermal noise comparison

- What noise reduction can be expected with waveguide mirrors?



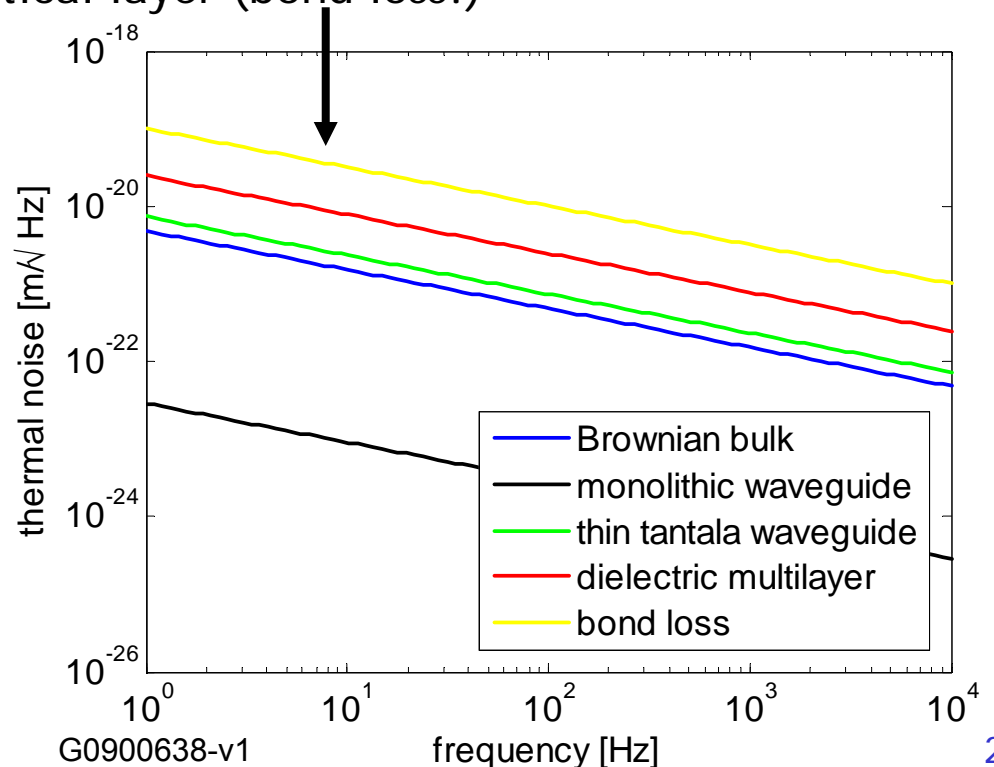
Advanced LIGO mirror geometry assumed.

\* systematic investigation of surface losses at low temperatures needed

# Monolithic Resonant Waveguide Concept

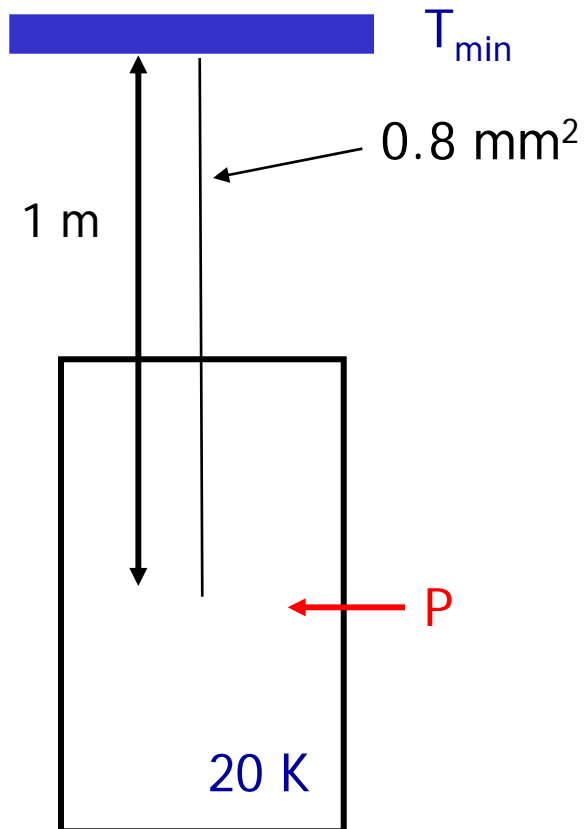
- open questions:
  - optical absorption @ 1550 nm and 20 K?
  - increased surface of silicon → surface loss analysis needed (poster @ Amaldi)
  - How to attach the optical layer (bond loss!)

bond loss ~ 0.1  
 waveguide fabricated on 500 μm wafer



# Thermal issues of the suspension

- heat extraction thru suspension



maximum extractable power  
(assuming high thermal conductivity)

$T_{\min}$ [K]	Silicon
2	28 mW
5	27 mW
10	23 mW
15	11 mW

# Summary

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- summary of thermal noise calculation on selected materials and geometries
- 150 kg might be useful and available, additional mass can be added in thickness without changing beam diameter
- coatings need to be improved:
  - better materials
  - thinner layer thicknesses (especially tantala)
  - reduction of thermal noise and thermal load by use of waveguides
- investigation of bond losses (mechanical and thermal!) will be very important for compound optics (waveguides, suspensions)
- see upcoming talks/poster about silicon optics @ Amaldi